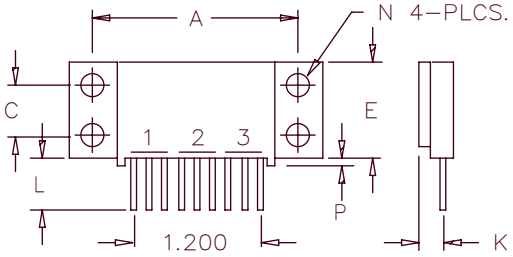
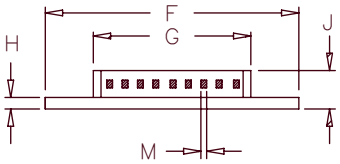
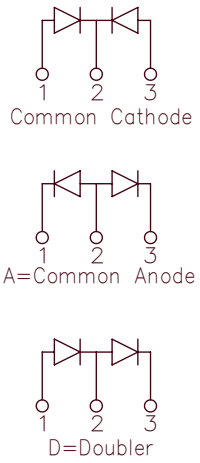
Schottky Powermod

FST6080 – FST60100







Notes:
Baseplate: Nickel plated copper; electrically isolated
Pins: Nickel plated copper

Dim.	Inches		Millimeter		
	Minimum	Maximum	Minimum	Maximum	Notes
A	1.995	2.005	50.67	50.93	
C	0.495	0.506	12.57	12.83	
E	0.990	1.010	25.15	25.65	
F	2.390	2.410	60.71	61.21	
G	1.490	1.510	37.85	38.35	
H	0.120	0.130	3.05	3.30	
J	---	0.400	---	10.16	
K	0.240	0.260	6.10	6.60	to Lead ℄
L	0.490	0.510	12.45	12.95	
M	0.040	.050	1.02	1.27	Square
N	0.175	0.195	4.45	4.95	Dia
P	0.032	0.052	0.81	1.32	

Microsemi Catalog Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
FST6080*	80V	80V
FST6090*	90V	90V
FST60100*	100V	100V

*Add the Suffix A for Common Anode, D for Doubler

- Schottky barrier rectifier
- Guard ring for reverse protection
- V_{RRM} – 80 to 100 Volts
- High surge capacity
- Reverse energy tested
- Electrically isolated baseplate
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg	$I_{F(AV)}$ 120 Amps	T_C = 130°C, Square wave, $R_{\theta JC}$ = 0.6°C/W
Average forward current per leg	$I_{F(AV)}$ 60 Amps	T_C = 130°C, Square wave, $R_{\theta JC}$ = 1.0°C/W
Maximum surge current per leg	I_{FSM} 1200 Amps	8.3 ms, half sine T_J = 175°C
Max repetitive peak reverse current per leg	$I_{R(OV)}$ 2 Amps	f = 1 KHz, 25°C, 1μsec Square wave
Max peak forward voltage per leg	V_{FM} .68 Volts	I_{FM} = 60A: T_J = 175°C*
Max peak forward voltage per leg	V_{FM} .86 Volts	I_{FM} = 60A: T_J = 25°C*
Max peak reverse current per leg	I_{RM} 30 mA	V_{RRM}, T_J = 125°C*
Max peak reverse current per leg	I_{RM} 2 mA	V_{RRM}, T_J = 25°C
Typical junction capacitance per leg	C_J 1500 pF	V_R = 5.0V, T_J = 25°C

*Pulse test: Pulse width 300μsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range	T_{STG}	−55°C to 175°C
Operating junction temp range	T_J	−55°C to 175°C
Maximum thermal resistance per leg	$R_{\theta JC}$	1.0°C/W Junction to case
Maximum thermal resistance per pkg	$R_{\theta JC}$	0.6°C/W Junction to case
Typical thermal resistance (greased)	$R_{\theta CS}$	0.1°C/W Case to sink
Mounting torque		15 – 20 inch pounds maximum
Weight		2.5 ounces (71 grams) typical

FST6080 – FST60100

Figure 1
Typical Forward Characteristics –Per Leg

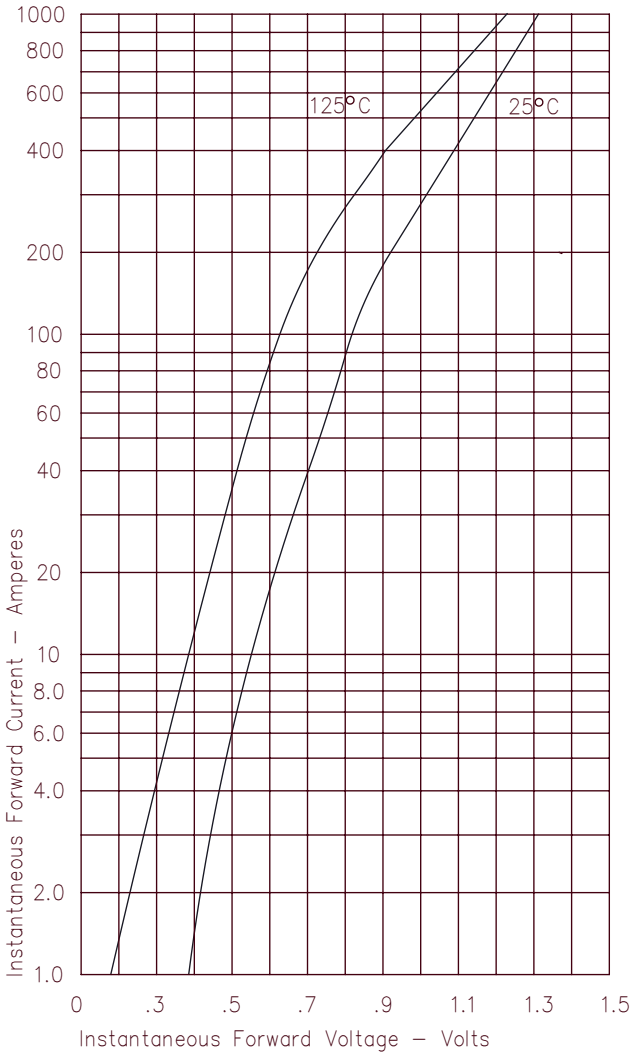


Figure 2
Typical Reverse Characteristics – Per Leg

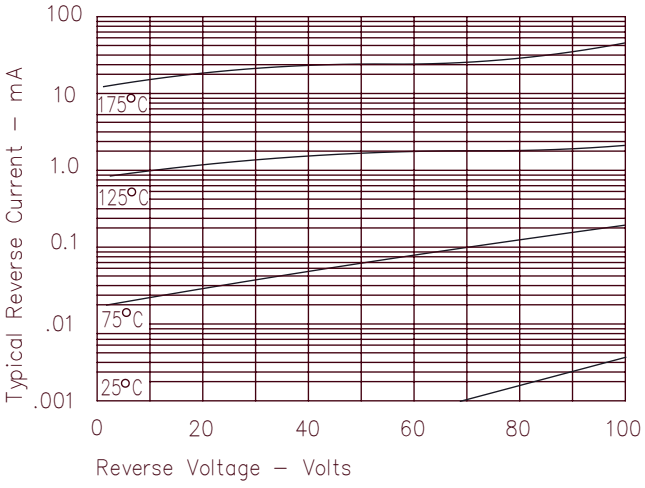


Figure 3
Typical Junction Capacitance – Per Leg

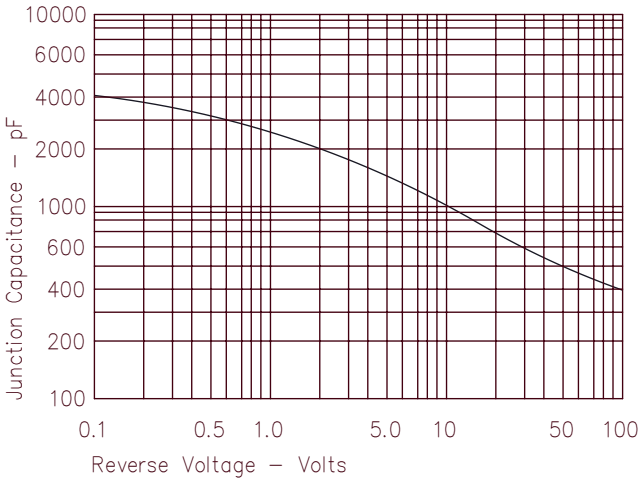


Figure 4
Forward Current Derating – Per Leg

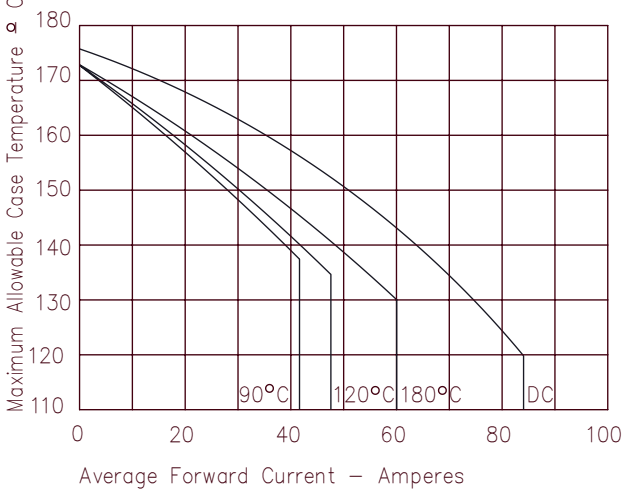
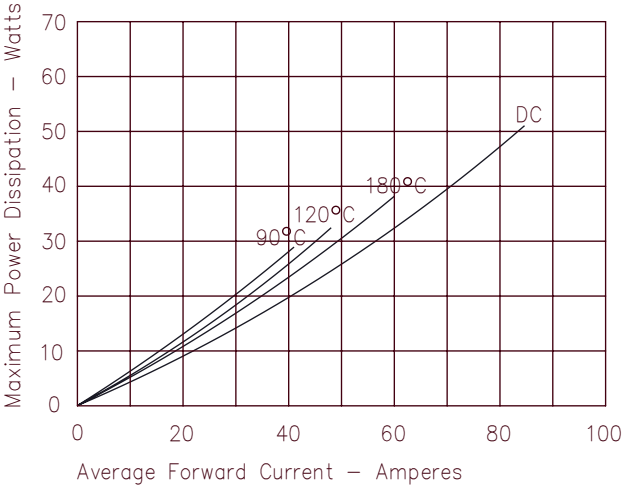


Figure 5
Maximum Forward Power Dissipation – Per Leg



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